



PRODUCT SPECIFICATION

PRODUCT SERIES NAME: A0801 SERIES

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1.SCOPE:

This specification covers the requirements for product performance of 0.80mm pitch wire to board connector series.

2.CONSTRUCTION 、 DIMENSIONS 、 MATERIAL & PLATING:

See the attached drawings

3.RATINGS & APPLICABLE WIRES:

Item	Standard	
Rated Voltage (max.)	30V AC, DC	
Rated Current (max.) and Applicable Wires	AWG #32	0.5A AC, DC
Ambient Temperature Range	-25°C ~ +85°C*	

*: Including terminal temperature rise

4.PERFORMANCE:

4-1.ELECTRICAL PERFORMANCE

Test Description	Procedure	Requirement
4-1-1 Contact Resistance	Mate connectors, measure by dry circuit, 20mV max., 10mA. (Based upon JIS C5402 5.4)	20mΩ max.
4-1-2 Insulation Resistance	Mate connectors, apply 500V DC between adjacent terminal or ground. (Based upon JIS C5402 5.2/ MIL-STD-202 Method 302 Cond. B)	100MΩ min.
4-1-3 Dielectric Withstanding Voltage	Mate connectors, apply 200V AC (rms) for 1 minute between adjacent terminal or ground. (Based upon JIS C5402 5.1/MIL-STD-202 Method 301)	No Breakdown
4-1-4 Contact Resistance on I.D.T. Portion	I.D.T. the applicable wire on to the terminal, measure by dry circuit, 20mV max., 10mA.	10mΩ max.

			APPROVED	CHECKED	WRITTEN
			BY	BY	BY
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4-2.MECHANICAL PERFORMANCE

Test Description		Procedure			Requirement
4-2-1	Insertion & Withdrawal Force	Insert and withdraw connectors at the speed rate of 25 ± 3mm/minute.			Refer to paragraph 5
4-2-2	I.D.T. Pull Out Force	Fix the I.D.T. terminal, apply axial pull out force on the wire at the speed rate of 25 ± 3mm/minute. (Based upon JIS C5402 6.8)	Axial direction	AWG #32	0.6kgf min.
			Vertical direction	AWG #32	0.3kgf min.
4-2-3	Pin Retention Force	Apply axial push force at the speed rate of 25 ± 3mm/minute.			0.3kgf min.
4-2-4	Durability	When mated up to 50 cycles repeatedly by the rate of 10 cycles per minute.	Contact Resistance	40mΩ max.	
4-2-5	Vibration	Amplitude: 1.5mm P-P Sweep time: 10-55-10 Hz in 1 minute Duration: 2 hours in each X.Y.Z. axes (Based upon MIL-STD-202 Method 201A)	Appearance	No Damage	
			Contact Resistance	40mΩ max.	
			Discontinuity	1μsec. max.	
4-2-6	Physical Shock	490m/s ² {50G}, 3 strokes in each X.Y.Z. axes. (Based upon JIS C0041/MIL-STD-202 Method 213B Cond. A)	Appearance	No Damage	
			Contact Resistance	40mΩ max.	
			Discontinuity	1μsec. max.	



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4-3.ENVIRONMENTAL PERFORMANCE AND OTHERS

Test Description		Procedure		Requirement	
4-3-1	Temperature Rise	Carrying rated current load. (Based upon UL 498)		Temperature Rise	30°C max.
4-3-2	Heat Resistance	85 ± 2°C, 96 hours (Based upon JIS C0021/MIL-STD-202 Method 108A Cond. A)		Appearance	No Damage
				Contact Resistance	40mΩ max.
4-3-3	Cold Resistance	-25 ± 3°C, 96 hours (Based upon JIS C0020)		Appearance	No Damage
				Contact Resistance	40mΩ max.
4-3-4	Humidity	Temperature: 40 ± 2°C Relative Humidity: 90 ~ 95% Duration: 96 hours (Based upon JIS C0022/MIL-STD-202 Method 103B Cond. B)		Appearance	No Damage
				Contact Resistance	40mΩ max.
				Insulation Resistance	10MΩ min.
				Dielectric Withstanding Voltage	Must meet 4-1-3
4-3-5	Temperature Cycling	5 cycles of: a) - 55°C 30 minutes b) +85°C 30 minutes (Based upon JIS C0025)		Appearance	No Damage
				Contact Resistance	40mΩ max.
4-3-6	Salt Spray	24 ± 4 hours exposure to a salt spray from the 5 ± 1% solution at 35 ± 2°C. (Based upon JIS C0023/MIL-STD-202 Method 101D Cond. B)		Appearance	No Damage
				Contact Resistance	40mΩ max.
4-3-7	SO ₂ Gas	24 hours exposure to 50 ± 5ppm. SO ₂ gas at 40 ± 2°C.		Appearance	No Damage
				Contact Resistance	40mΩ max.
4-3-8	NH ₃ Gas	40 minutes exposure to NH ₃ gas evaporating from 28% Ammonia solution.		Appearance	No Damage
				Contact Resistance	40mΩ max.
4-3-9	Solderability	Soldering Time: 5 ± 0.5 sec. Solder Temperature: 245 ± 5°C		Solder Wetting	95% of immersed area must show no voids, pin holes
4-3-10	Resistance to Soldering Heat	<u>When reflowing</u> Refer to paragraph 6 <u>Solder iron method</u> Soldering Time: 5 ± 0.5 sec. Solder Temperature: 370°C ~ 400°C		Appearance	No Damage



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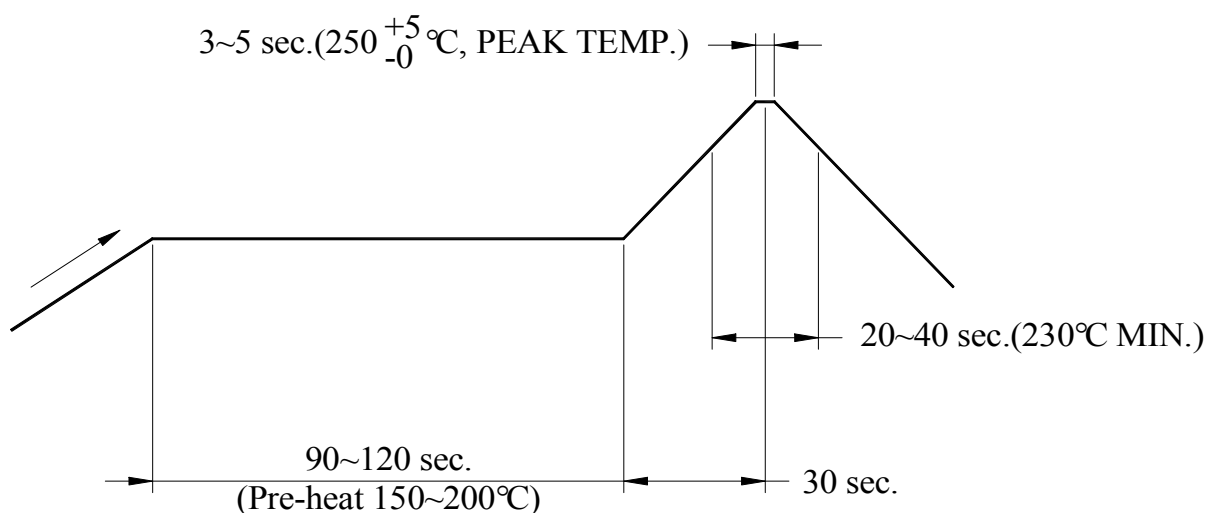
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5.INSERTION/WITHDRAWAL FORCE:

No. of circuits	Insertion (kgf max.)	Withdrawal (kgf min.)
2	0.50	0.10
4	0.70	0.14
8	1.10	0.22
10	1.30	0.26
12	1.50	0.30
14	1.70	0.34
15	1.80	0.36
16	1.90	0.38
17	2.00	0.40
20	2.30	0.46

6.INFRARED REFLOW CONDITION:



TEMPERATURE CONDITION GRAPH
(TEMPERATURE ON BOARD PATTERN SIDE)

NOTE: Please check the mount condition(reflow soldering condition) by your own devices beforehand, because the condition changes by the soldering devices, p.c.boards, and so on. No moisture treatment before reflow process.